

INFORMATION
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Applicant: Simon FENNEY, et al

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U.S. PATENT DOCUMENTS

Examiner Initial*	Document Number	Date	Name	Class	Sub Class	Filing Date
<i>kw</i>	AA 949 424 5	Sep 1999	Cabral, et al			
	AB					
	AC					
	AD					
	AE					
	AF					
	AG					
	AH					
	AI					
	AJ					
	AK					

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FOREIGN PATENT DOCUMENTS

	Document Number	Date	Country	Class	Sub Class	Translation Yes No
<i>kw</i>	AL WO 95/27268	Oct 1995	WIPO			
<i>kw</i>	AM EP 1 004 094 B1	Oct 2002	EPO			
	AN					
	AO					
	AP					

OTHER DOCUMENTS (Including Author, Title, Date, Pages, Etc.)

<i>kw</i>	AR	BLINN, James F.; "Simulation of Wrinkled Surfaces", SIGGRAPH 1978, pp. 286-292
<i>kw</i>	AS	PEERCY, Mark, et al; "Efficient Bump Mapping Hardware", SIGGRAPH 1997, pp. 303-306

EXAMINER

Kimberly Nguyen

DATE CONSIDERED

11-8-05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.